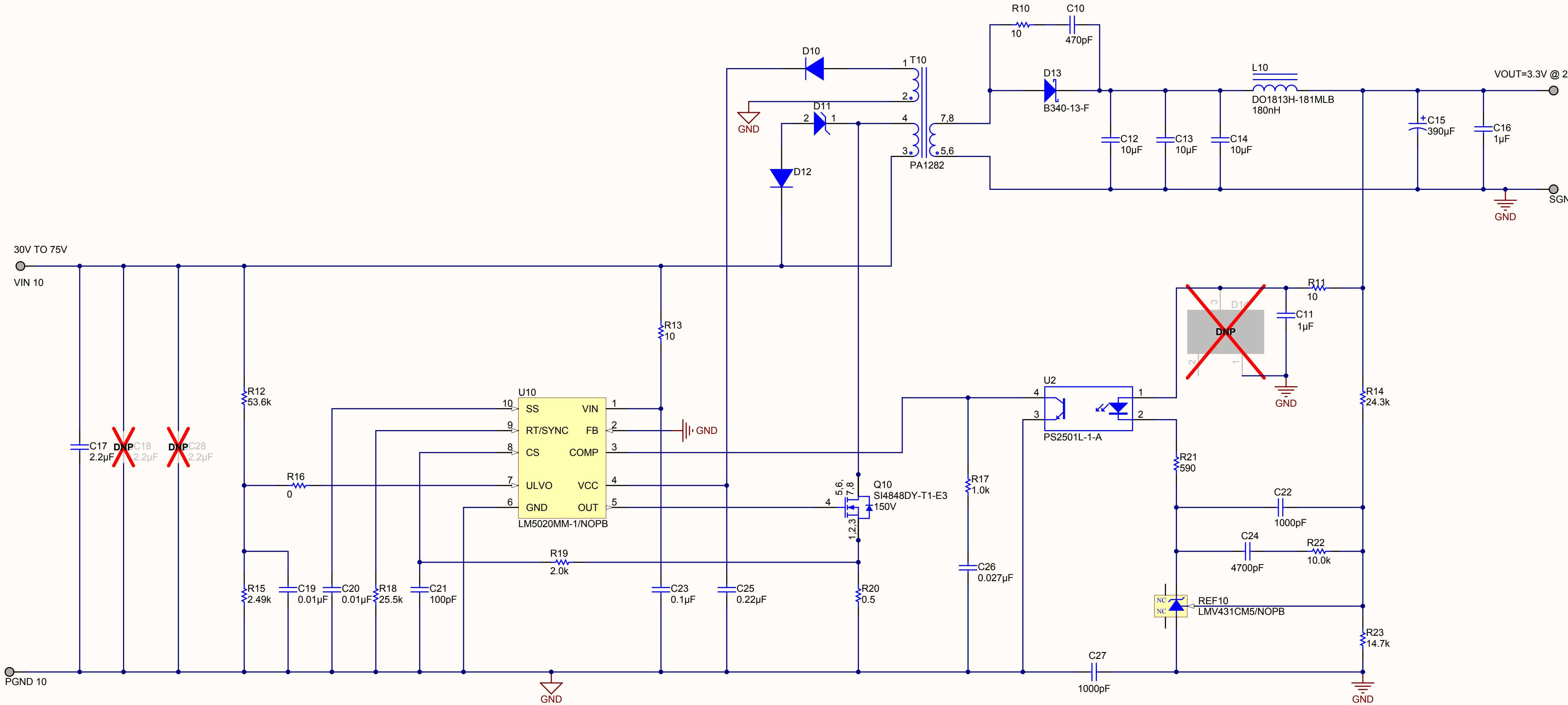




Revision History	
Revision	Notes

Place Block Diagram here (if appropriate) or delete this text box.
If using a block diagram from another tool, save the picture as a .bmp file.
Then, use menu Place|Drawing Tools|Graphic to insert the .bmp file on the schematic.

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